PLACEMENT STATISTICS FOR THE PLACEMENT YEAR 2021-22 (as on 30.05.2022)

Sl. No.	Course	Branch	Total Students	Total Students (Eligible*)	Placed	Perce ntage	Max. Sal (LPA)	Min. Sal. (LPA)	Median (LPA)	Avg. Sal. LPA	Total
1.		Civil Engineering	109	73	60	82.2	16	3.75	8.1	8.93	
2.		Electrical & Electronics Engineering	133	113	103	91.2	32.5	4.75	12	14.9 4	
3.		Mechanical Engineering	154	119	114	95.8	37	4.5	10	11.0 5	646
4.		Electronics & Communication Engineering	140	113	107	94.7	45.03	6	17.73	18.9 6	
5.	B.Tech.	Metallurgical & Materials Engineering	57	38	30	78.9	32	6	10.5	12.8 3	
6.	D. IECII.	Chemical Engineering	103	74	70	94.6	26.1	4.5	9.02	10.0 9	
7.		Computer Science & Engineering	143	129	128	99.2	62.5	6.5	25.4	25.5	
8.		Bio-Technology	60	42	34	81	31.5	6	9.02	10.6 2	
9.		Water Resource Engineering	27	19	7	36.8	16	5	8	9.37	
10.		Environmental Engineering	27	27	18	66.7	10	5	8	7.03	
11.		Engineering Structures	27	26	19	73.1	8.6	4	6.3	6.55	
12.		Geo-Tech. Engineering	25	21	5	23.8	12	5	7	7.8	0.1
13.	M.Tech	Transportation Engineering	25	21	14	66.7	16	4.2	6	7.99	91
14.	(Civil)	Construction Technology & Management	25	22	17	77.3	16	6	7	8.94	
15.		Remote Sensing & GIS	19	18	8	44.4	16	7.56	10	11.05	
16.		Waste Management	16	15	3	20	12	6	12	10	
17.		Power Systems Engineering	19	19	13	68.4	19.5	7	10	11.0 6	
18.	M.Tech . (EEE)	Power Electronics and Drives	30	28	21	75	19.5	4.2	10	10.2 3	53
19.	, ,	Smart Electric Grid	21	22	19	86.4	15	5	10	10.4 7	
20.		Thermal Engineering	16	16	14	87.5	10	5	7	7.54	
21.		Manufacturing Engineering	20	19	15	78.9	12.5	4.8	10	9.19	
22.		Computer Integrated Manufacturing	20	16	10	62.5	14.06	5	6.75	7.8	
23.	M.Tech	Machine Design	20	18	15	83.3	12	5	10	8.57	88
24.	(Mech.	Automobile Engineering	18	16	15	93.8	16	4.8	10.23	10.0 6	
25.	,	Materials & Systems Engineering Design	14	13	11	84.6	12	6.75	10	9.32	
26.		Additive Manufacturing	8	8	8	100	12	4.8	9	8.01	

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27.	M.Tech .(ECE)	Electronic Instrumentation	24	23	13	56.5	31.5	7.5	15	17.7	43
28.		VLSI System Design	19	18	13	72.2	32.7	15	20.46	21.6 4	
29.		Advanced Communication System	21	19	17	89.5	31.5	6.75	11	15.3 7	
30.	M. Tech. (MME)	Industrial Metallurgy	19	17	5	29.4	12	4.8	5	7.36	12
31.		Material Technology	19	16	7	43.8	16	4.3	4.8	9.08	
32.	M.Tech. (Ch.E)	Chemical Engineering	20	15	9	60	19.62	4	6.5	8.23	17
33.		Process Control	13	17	8	47.1	15	5.5	10	10.7	
34.	M.Tech.	Computer Science & Engineering	23	23	22	95.7	45.03	4.5	18.66	21.9	4.4
35.	(CS&E)	CS & Information Security	23	23	22	95.7	45.03	10.23	17.2	22.1 3	44
36.	M.Tech (BT)	Bio-Technology	15	14	6	42.9	12	6.5	10	9.25	6
37.	M.C.A.	Master of Computer Applications	55	50	50	100	36	6.5	10	13.4	50
38.	M.B.A.	Master of Business Administration	39	37	32	86.5	15	5	6	6.99	32
39.	M.Sc. (Math)	Applied Mathematics	26	25	11	44	12	6	10	8.63	33
40.		Mathematics & Scientific Computing	27	24	22	91.7	32	6.75	11.4	11.4 8	
41.	M.Sc. (Tech.)	Engineering Physics	40	36	6	16.7	17	7	8.2	9.64	6
42.	M.Sc. (Chem.)	Analytical Chemistry (MMCA)	27	23	6	26.1	16	4.8	5.5	7.2	11
43.		Organic Chemistry (DDPP)	26	21	5	23. 8	16	6	6	9.2	11

*Includes students with CGPA>=6.5 and who participated in all Campus Placement Drives. If a Company has offered a job to a student having CGPA<6.5, it is included in both placed as well as registered counts. Students CGPA considered for eligibility is whatever the student acquired upto the date of commencement of placement session